MOSFET – Small Signal, Complementary, SC-88 20 V / -8.0 V, +0.63 Å / -0.775 A

Features

- Complementary N and P Channel Device
- Leading -8.0 V Trench for Low R_{DS(on)} Performance
- ESD Protected Gate ESD Rating: Class 1
- SC-88 Package for Small Footprint (2 x 2 mm)
- Pb-Free Packages are Available

Applications

- DC-DC Conversion
- Load/Power Switching
- Single or Dual Cell Li-Ion Battery Supplied Devices
- Cell Phones, MP3s, Digital Cameras, PDAs

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Paramet	Symbol	Value	Unit		
Drain-to-Source Voltage	N-Ch	V _{DSS}	20	V	
		P-Ch		-8.0	
Gate-to-Source Voltage		N-Ch	V _{GS}	±12	V
		P-Ch		±8.0	
Continuous Drain Current	N-Ch	$T_A = 25^{\circ}C$	۱ _D	0.63	А
– Steady State (Based on R _{θJA})		T _A = 85°C		0.46	
(Daded off heja)	P-Ch	T _A = 25°C		-0.775	
		T _A = 85°C		-0.558	
Continuous Drain Current	N-Ch	T _A = 25°C		0.91	
– Steady State (Based on R _{0JL})		T _A = 85°C		0.65	
(Dased on hejt)	P-Ch	T _A = 25°C		-1.1	
		T _A = 85°C		-0.8	
Pulsed Drain Current	Pulsed Drain Current			±1.2	А
Power Dissipation - Steady	/ State	T _A = 25°C	PD	0.27	W
(Based on $R_{\theta JA}$)		T _A = 85°C		0.14	
Power Dissipation - Steady	/ State	T _A = 25°C		0.55	
(Based on $R_{\theta JL}$)	T _A = 85°C		0.29		
Operating Junction and Sto	T _J , T _{STG}	–55 to 150	°C		
Source Current (Body Diod	N-Ch	۱ _S	0.63	А	
	P-Ch		-0.775		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE RATINGS (Note 1)

Junction-to-Ambient	Тур	$R_{\theta JA}$	400	°C/W
 Steady State 	Max		460	
Junction-to-Lead (Drain)	Тур	$R_{\theta JL}$	194	
 Steady State 	Max]	226	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

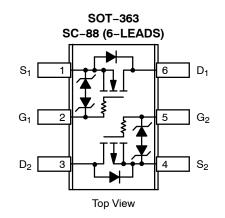
1. Surface mounted on FR4 board using 1 oz Cu area = 0.9523 in sq.

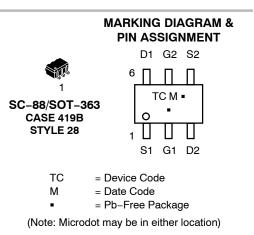


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V _{(BR)DSS}	R _{DS(on)} TYP	I _D Max	
N-Ch 20 V	0.29 Ω @ 4.5 V		
	0.36 Ω @ 2.5 V	0.63 A	
	0.22 Ω @ –4.5 V		
P–Ch –8.0 V	0.32 Ω @ –2.5 V	–0.775 A	
	0.51 Ω @ –1.8 V		





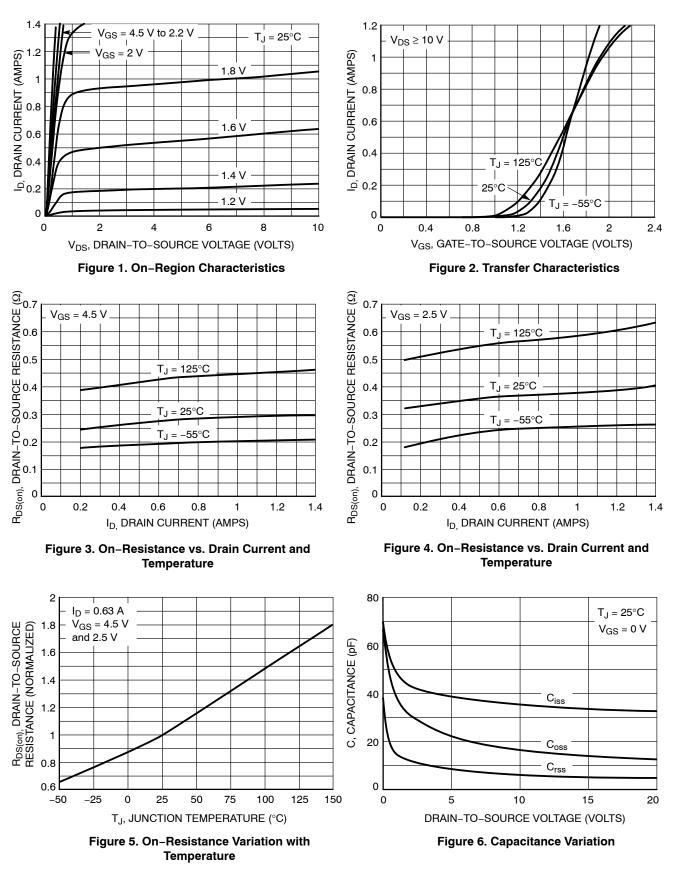
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

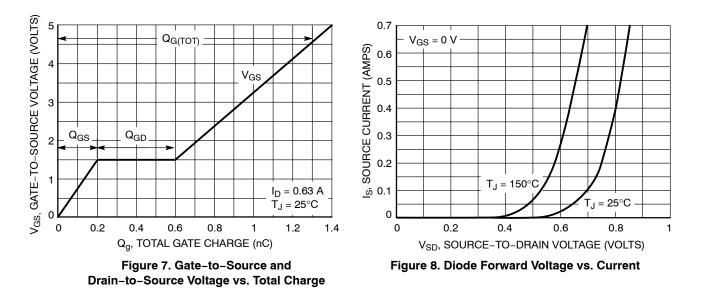
Parameter	Symbol	N/P	Test Conditio	on	Min	Тур	Max	Units
OFF CHARACTERISTICS								
Drain-to-Source	V _{(BR)DSS}	Ν	V _{GS} = 0 V	I _D = 250 μA	20	27		V
Breakdown Voltage		Р	VGS - 0 V	I _D = -250 μA	-8.0	-10.5		
Drain-to-Source Breakdown	V _{(BR)DSS}	Ν				22		mV/ °C
Voltage Temperature Coeffi- cient	`∕ŤJ	Р				-6.0		
Zero Gate Voltage Drain Cur-	I _{DSS}	N	V _{GS} = 0 V, V _{DS} = 16 V				1.0	μΑ
rent	.033	P	$V_{GS} = 0 V, V_{DS} = -6.4 V$	T _J = 25 °C			1.0	μαι
Gate-to-Source	I _{GSS}	Ν		V _{GS} = ±12 V			10	μΑ
Leakage Current		Р	$V_{DS} = 0 V$	V _{GS} = ±8.0			10	
ON CHARACTERISTICS (Note 2	<u>2)</u>							
Gate Threshold Voltage	V _{GS(TH)}	Ν	V _{GS} = V _{DS}	I _D = 250 μA	0.6	0.92	1.5	V
		Р	VGS - VDS	I _D = -250 μA	-0.45	-0.83	-1.0	
Gate Threshold	V _{GS(TH)} / T _J	Ν				-2.1		–mV/ °C
Temperature Coefficient		Р				2.2		
Drain-to-Source On Resist- ance	R _{DS(on)}	N	V _{GS} = 4.5 V I _D = 0			0.29	0.375	Ω
		P	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.5 \text{ V}$			0.22	0.30	4
		N P	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0$			0.36	0.445	-
		P	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -2.5 \text{ V}$			0.32	0.46	
Forward Transconductance		P N	V _{GS} = -1.8 V, I _D = - V _{DS} = 4.0 V I _D = 0			0.51	0.90	S
Forward Transconductance	9fs	P	$V_{DS} = 4.0 \text{ V}_{ID} = 0.0 \text{ V}_{DS} = -4.0 \text{ V}_{ID} = 0.0 \text{ V}_{DS} = -4.0 \text{ V}_{DS} = -4.0$			2.0 2.0		
CHARGES AND CAPACITANCE		Г	$v_{\rm DS} = -4.0 v, i_{\rm D} = -4.0 v$	-0.57 A		2.0		
Input Capacitance		N		V _{DS} = 20 V		33	46	pF
input Capacitance	C _{ISS}	P		$V_{DS} = 20 V$ $V_{DS} = -8.0V$		160	40 225	pi
Output Capacitance	C _{OSS}	Г N		$V_{DS} = -8.0V$ $V_{DS} = 20 V$		13	223	
	Coss	P	f = 1 MHz, V _{GS} = 0 V	$V_{\rm DS} = 20 V$ $V_{\rm DS} = -8.0 V$		38	55	
Reverse Transfer Capacitance	C _{RSS}	N		$V_{DS} = -0.0 V$ $V_{DS} = 20 V$		2.8	5.0	-
	ORSS	P		$V_{DS} = 20 V$ $V_{DS} = -8.0 V$		2.0	40	
Total Gate Charge	Q _{G(TOT)}	N	V _{GS} = 4.5 V, V _{DS} = 10 V			1.3	3.0	nC
5	·u(101)	P	$V_{GS} = -4.5 \text{ V}, \text{ V}_{DS} = -5.0$			2.2	4.0	
Threshold Gate Charge	Q _{G(TH)}	Ν	V _{GS} = 4.5 V, V _{DS} = 10 V			0.1		
C C	G()	Р	$V_{GS} = -4.5 \text{ V}, \text{ V}_{DS} = -5.0$			0.1		
Gate-to-Source Charge	Q _{GS}	Ν	V _{GS} = 4.5 V, V _{DS} = 10 V			0.2		
		Р	V_{GS} = -4.5 V, V_{DS} = -5.0	V, I _D = -0.6 A		0.5	1	
Gate-to-Drain Charge	Q _{GD}	Ν	V _{GS} = 4.5 V, V _{DS} = 10 V	/, I _D = 0.7 A		0.4		
		Р	V_{GS} = -4.5 V, V_{DS} = -5.0	V, I _D = -0.6 A		0.5		
SWITCHING CHARACTERISTIC	CS (Note 3)							
Turn-On Delay Time	t _{d(ON)}	Ν				0.083		μs
Rise Time	t _r		V _{GS} = 4.5 V, V _{DD} =	= 10 V,		0.227		
Turn-Off Delay Time	t _{d(OFF)}		I _D = 0.5 A, R _G =	20 Ω		0.786		l
Fall Time	t _f					0.506		
Turn-On Delay Time	t _{d(ON)}	Р				0.013		l
Rise Time	t _r	1	$V_{GS} = -4.5 V, V_{DD} =$			0.023		
Turn-Off Delay Time	t _{d(OFF)}	4	I_D = -0.5 A, R_G = 8.0 Ω			0.050		1
Fall Time	t _f					0.036		
DRAIN-SOURCE DIODE CHAR		CS						
Forward Diode Voltage	V _{SD}	N	V _{GS} = 0 V, T _J = 25°C	I _S = 0.23 A		0.76	1.1	V
		P		I _S = -0.23 A		0.76	1.1	1
		N	V _{GS} = 0 V, T _J = 125°C	I _S = 0.23 A		0.63		1
	<u> </u>	Р		I _S = -0.23 A		0.63		ļ
Reverse Recovery Time	t _{RR}	N	$V_{GS} = 0 V$,	I _S = 0.23 A		0.410	ļ	μs
		Р	d _{IS} /d _t = 90 A/µs	I _S = -0.23 A		0.078		

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.



TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



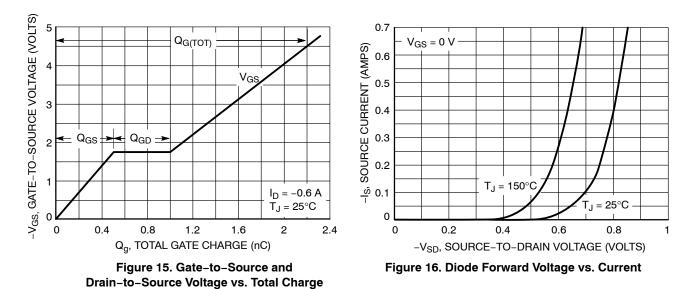
1.4 1.4 $V_{GS} = -4.5 \text{ V to } -2.6 \text{ V}$ T_J = 25°C $V_{DS} \ge -10 V$ $V_{GS} = -2.2 V$ -ID, DRAIN CURRENT (AMPS) -ID, DRAIN CURRENT (AMPS) 1.2 1.2 .2 V –1.8 V 1 1 0.8 0.8 –1.6 V 0.6 0.6 0.4 0.4 T_{.1} = 125°C -1.4 V 25°C 0.2 0.2 -1.2 V -55°C ГJ 0 0 0 2 8 4 6 0.4 0 0.8 1.6 2 2.4 1.2 -VGS, GATE-TO-SOURCE VOLTAGE (VOLTS) -V_{DS}, DRAIN-TO-SOURCE VOLTAGE (VOLTS) Figure 9. On–Region Characteristics Figure 10. Transfer Characteristics R_{DS(on)}, DRAIN-TO-SOURCE RESISTANCE (2) 0 1 0 0 0 0 0 0 0 0 0 0 0 $R_{DS(on)}$, DRAIN-TO-SOURCE RESISTANCE (Ω) 0.5 V_{GS} = -4.5 V V_{GS} = -2.5 V T_J = 125°C 0.4 T_{.1} = 25°C 0.3 T_{.1} = 125°C $T_J = -55^{\circ}C$ T_J = 25°C 0.2 $T_{.1} = -55^{\circ}C$ 0.1 0 0 0.2 0.4 0.6 0.8 1 1.2 1.4 0 0.2 0.4 0.6 0.8 1 1.2 1.4 -ID. DRAIN CURRENT (AMPS) -ID. DRAIN CURRENT (AMPS) Figure 12. On-Resistance vs. Drain Current Figure 11. On-Resistance vs. Drain Current and Temperature and Temperature 300 1.6 $T_J = 25^{\circ}C$ $I_{\rm D} = -0.7 ~\rm{A}$ V_{GS} = -4.5 V V_{GS} = 0 V R_{DS(on)}, DRAIN-TO-SOURCE RESISTANCE (NORMALIZED) 240 and -2.5 V 1.4 C, CAPACITANCE (pF) C_{iss} 1.2 180 120 1 C, 0.8 60 C_{rss} 0.6 0 100 -50 -25 0 25 50 75 125 150 -8 -6 -4 -2 0 GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS) T_J, JUNCTION TEMPERATURE (°C) Figure 13. On-Resistance Variation with Figure 14. Capacitance Variation

TYPICAL P-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

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Temperature

TYPICAL P-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



ORDERING INFORMATION

Device	Package	Shipping [†]	
NTJD4105CT1	SOT-363	3000 / Tape & Reel	
NTJD4105CT1G	SOT-363 (Pb-Free)	3000 / Tape & Reel	
NTJD4105CT2	SOT-363	3000 / Tape & Reel	
NTJD4105CT2G	SOT-363 (Pb-Free)	3000 / Tape & Reel	
NTJD4105CT4	SOT-363	10,000 / Tape & Reel	
NTJD4105CT4G	SOT-363 (Pb-Free)	10,000 / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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